2SD1535

Silicon NPN triple diffusion planar type darlington

For high power amplification

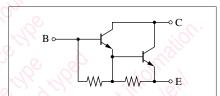
■ Features

- Excellent collector current I_C characteristics of forward current transfer ratio h_{FE}
- High collector-base voltage (Emitter open) V_{CBO}
- Wide safe operation area
- Full-pack package which can be installed to the heat sink with one screw

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	500	V	
Collector-emitter voltage (Base open)	V_{CEO}	400	V	
Emitter-base voltage (Collector open)	V_{EBO}	12	V	
Collector current	I_{C}	7	A	
Peak collector current	I_{CP}	14	A	
Base current	I_{B}	0.5	A	
Collector power	P_{C}	50	W	
dissipation $T_a = 25^{\circ}C$		2.0		
Junction temperature	T _j	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	

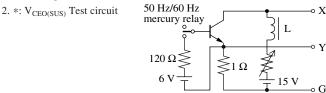
Internal Connection

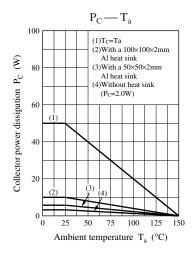


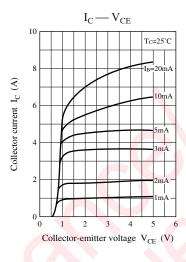
■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

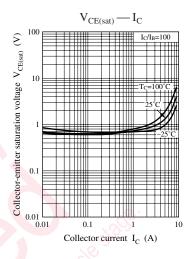
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter sustaining voltage *	V _{CEO(SUS)}	$I_C = 100 \text{ mA}, R_{BE} = \infty, L = 25 \text{ mH}$	400	, YC	•	V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 500 \text{ V}, I_E = 0$	100	0,	100	μΑ
Collector-emitter cutoff current (Base open)	I_{CEO}	$V_{CE} = 400 \text{ V}, I_{B} = 0$)-	100	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 12 \text{ V}, I_C = 0$	1.90		100	mA
Forward current transfer ratio	h _{FE1}	$V_{CE} = 2 \text{ V}, I_{C} = 2 \text{ A}$	500			_
	h _{FE2}	$V_{CE} = 2 \text{ V}, I_{C} = 6 \text{ A}$	200			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 7 \text{ A}, I_B = 70 \text{ mA}$			2.0	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_C = 7 \text{ A}, I_B = 70 \text{ mA}$			2.5	V
Transition frequency	f_T	$V_{CE} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		70		pF
Turn-on time	t _{on}	$I_C = 7 \text{ A}, I_{B1} = 70 \text{ mA}, I_{B2} = -70 \text{ mA},$		1.5		μs
Storage time	t _{stg}	$V_{CC} = 300 \text{ V}$		5.0		μs
Fall time	$t_{\rm f}$			6.5		μs

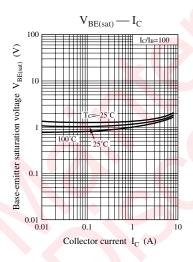
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

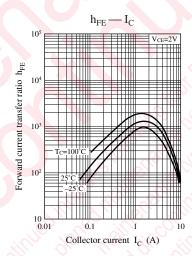


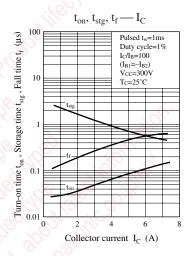


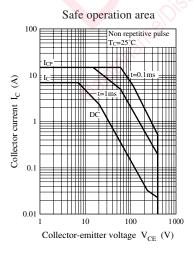


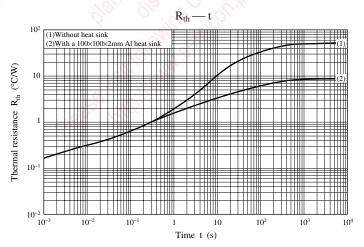












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